

2MBI200N-060

IGBT Module

600V / 200A 2 in one-package

■ Features

- High speed switching
- Voltage drive
- Low inductance module structure

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply
- Industrial machines, such as Welding machines



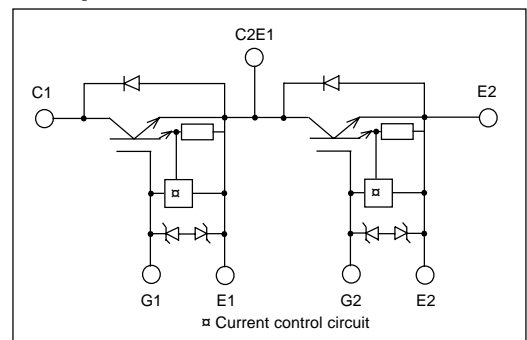
■ Maximum ratings and characteristics

● Absolute maximum ratings (at Tc=25°C unless otherwise specified)

Item	Symbol	Rating	Unit
Collector-Emitter voltage	V _{CEs}	600	V
Gate-Emitter voltage	V _{GEs}	±20	V
Collector current	Continuous	I _c	200
	1ms	I _c pulse	400
	Continuous	-I _c	200
	1ms	-I _c pulse	400
Max. power dissipation	P _c	780	W
Operating temperature	T _j	+150	°C
Storage temperature	T _{stg}	-40 to +125	°C
Isolation voltage	V _{is}	AC 2500 (1min.)	V
Screw torque	Mounting *1	3.5	N·m
	Terminals *1	3.5	N·m

*1 : Recommendable value : 2.5 to 3.5 N·m(M5)

■ Equivalent Circuit Schematic



● Electrical characteristics (at Tj=25°C unless otherwise specified)

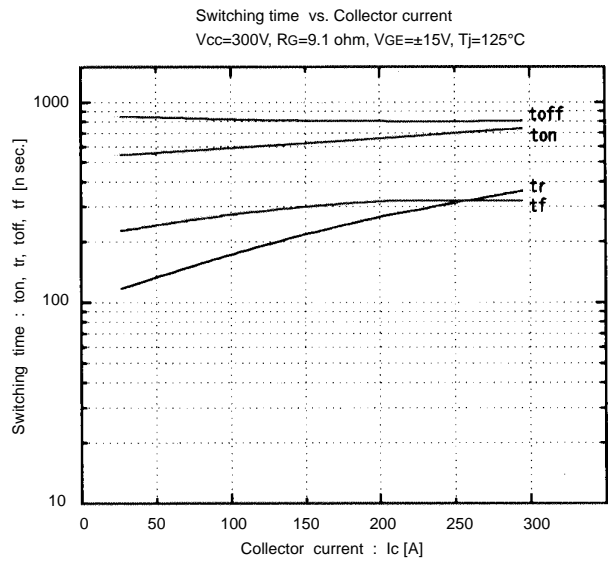
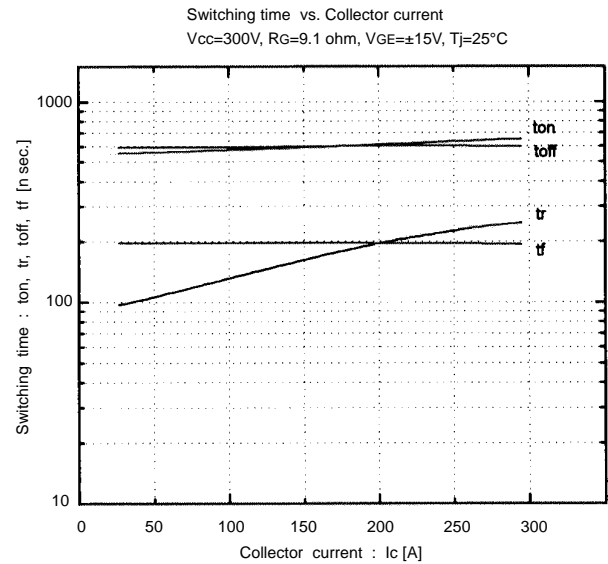
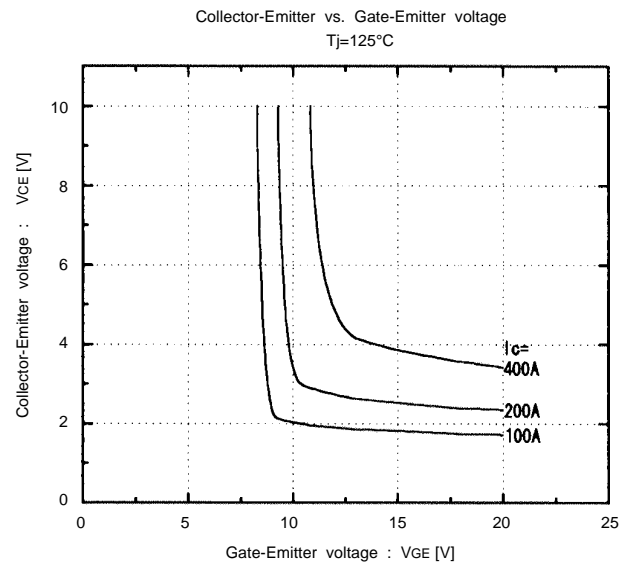
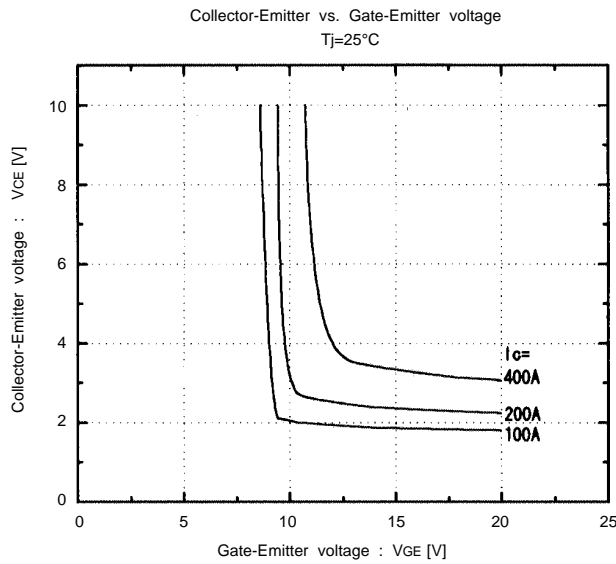
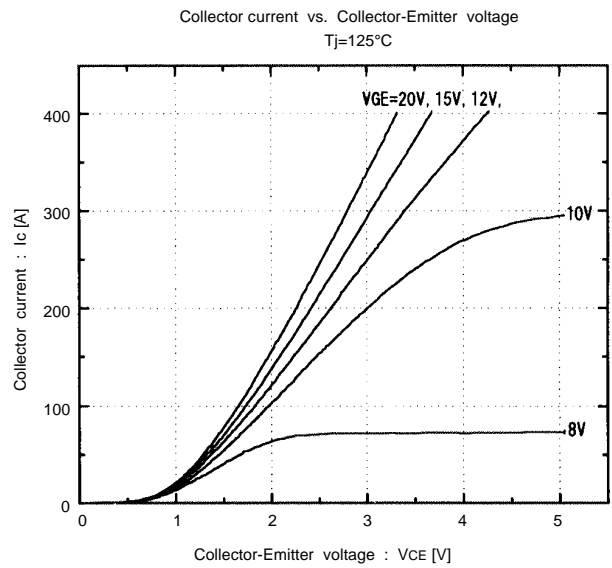
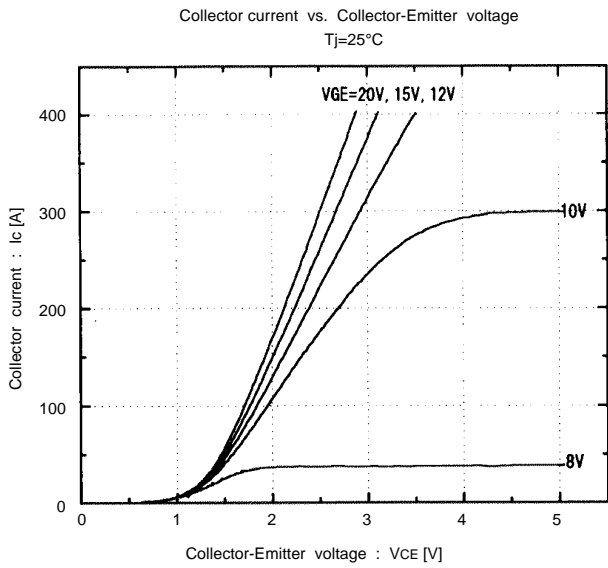
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	I _{CEs}	–	–	2.0	V _{GE} =0V, V _{CE} =600V	mA
Gate-Emitter leakage current	I _{GES}	–	–	30	V _{CE} =0V, V _{GE} =±20V	μA
Gate-Emitter threshold voltage	V _{GE(th)}	4.5	–	7.5	V _{CE} =20V, I _c =200mA	V
Collector-Emitter saturation voltage	V _{CE(sat)}	–	–	2.8	V _{GE} =15V, I _c =200A	V
Input capacitance	C _{ies}	–	13200	–	V _{GE} =0V	pF
Output capacitance	C _{oes}	–	2930	–	V _{CE} =10V	
Reverse transfer capacitance	C _{res}	–	1330	–	f=1MHz	
Turn-on time	t _{on}	–	0.6	1.2	V _{CC} =300V	μs
	t _r	–	0.2	0.6	I _c =200A	
Turn-off time	t _{off}	–	0.6	1.0	V _{GE} =±15V	μs
	t _f	–	0.2	0.35	R _G =9.1 ohm	
Diode forward on voltage	V _F	–	–	3.0	I _F =200A, V _{GE} =0V	V
Reverse recovery time	t _{rr}	–	–	0.3	I _F =200A	μs

● Thermal resistance characteristics

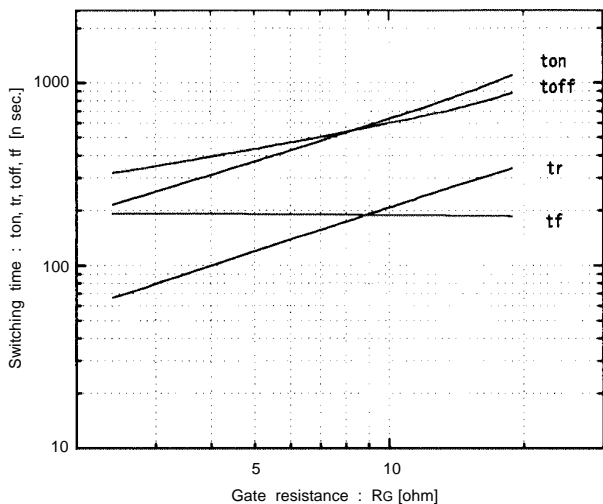
Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	R _{th(j-c)}	–	–	0.16	IGBT	°C/W
	R _{th(j-c)}	–	–	0.35	Diode	°C/W
	R _{th(c-f)*2}	–	0.025	–	the base to cooling fin	°C/W

*2 : This is the value which is defined mounting on the additional cooling fin with thermal compound

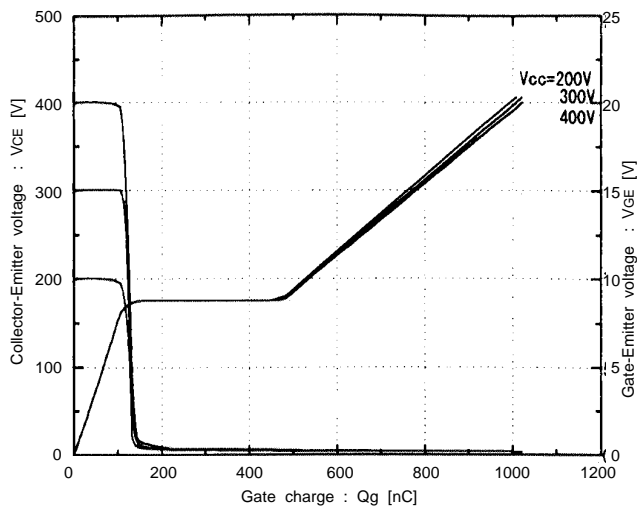
Characteristics (Representative)



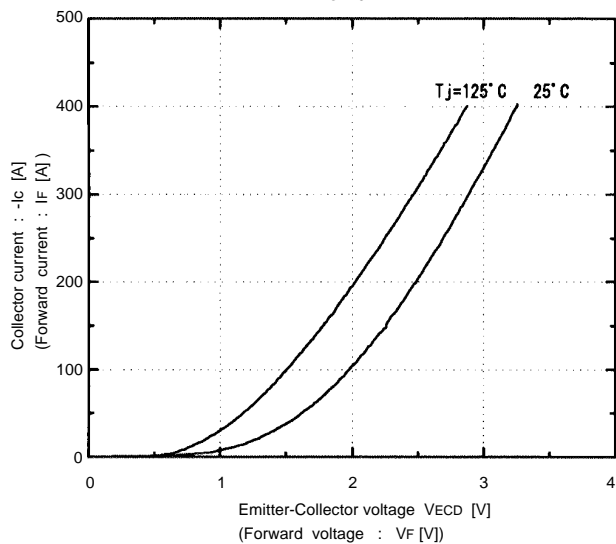
Switching time vs. R_G
 $V_{CC}=300V, I_C=200A, V_{GE}=\pm 15V, T_J=25^\circ C$



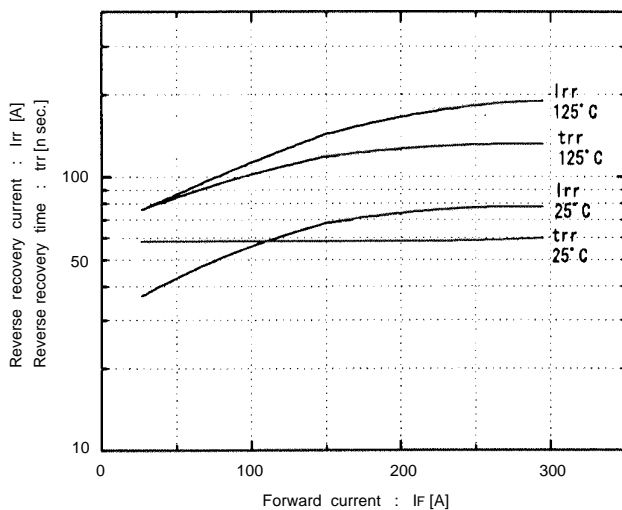
Dynamic input characteristics
 $T_J=25^\circ C$



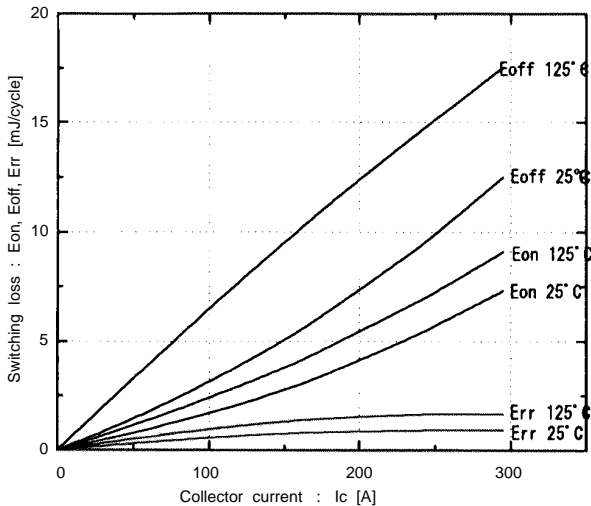
Forward current vs. Forward voltage
 $V_{GE}=0V$



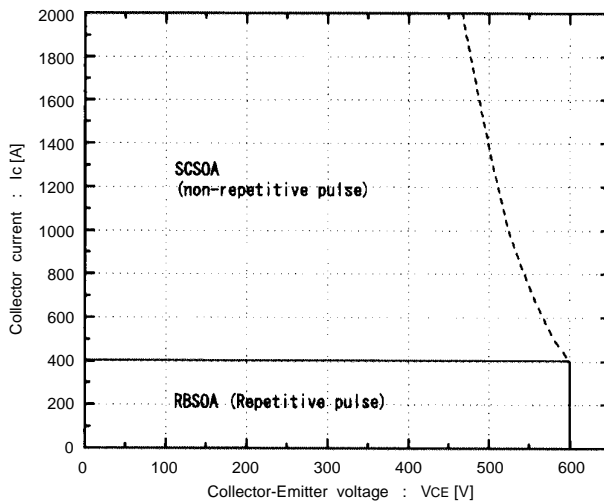
Reverse recovery characteristics
 t_{rr}, I_{rr} vs. I_F

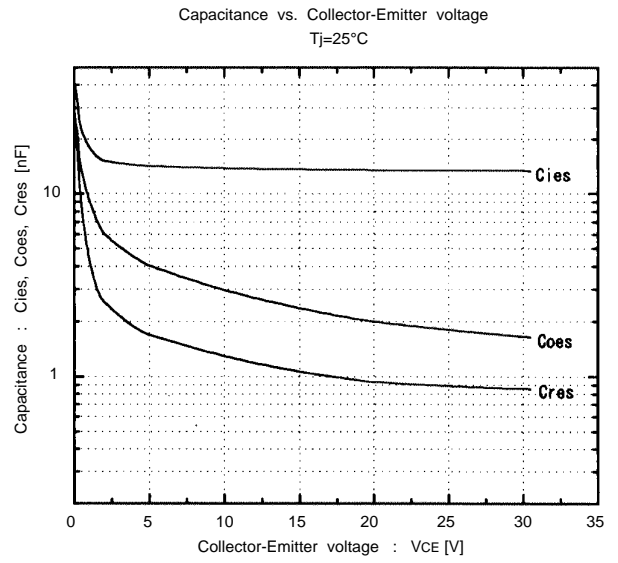
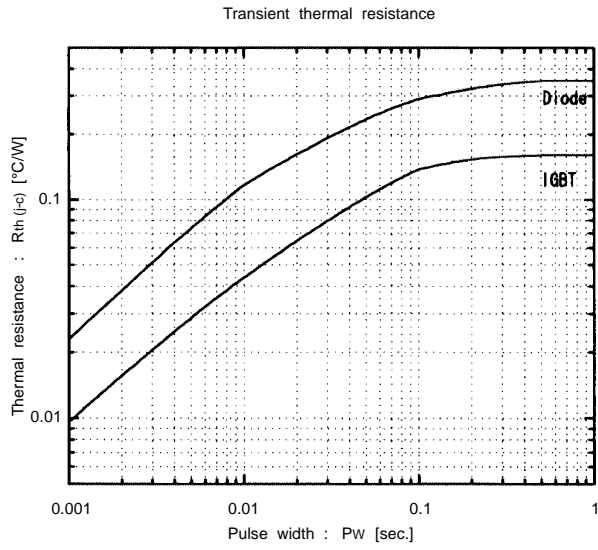


Switching loss vs. Collector current
 $V_{CC}=300V, R_G=9.1\text{ ohm}, V_{GE}=\pm 15V$



Reversed biased safe operating area
 $+V_{GE}=15V, -V_{GE} \le 15V, T_J \le 125^\circ C, R_G \ge 9.1\text{ ohm}$





■ Outline Drawings, mm

